

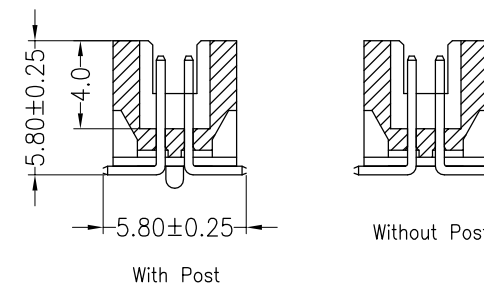
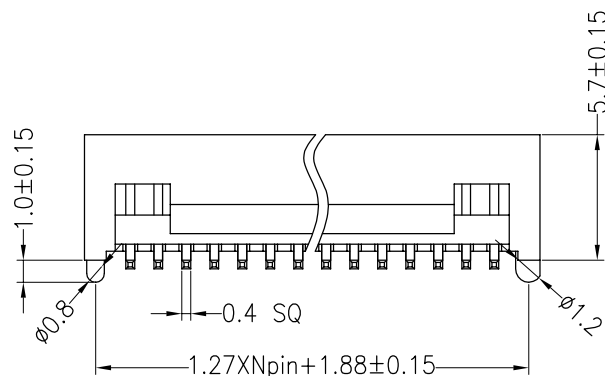
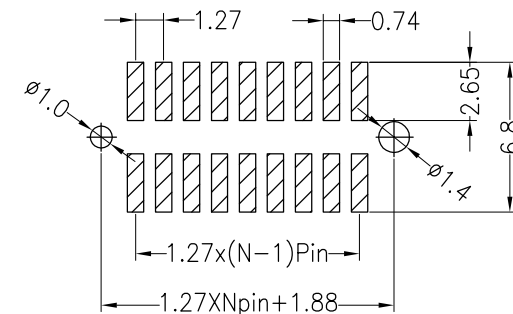
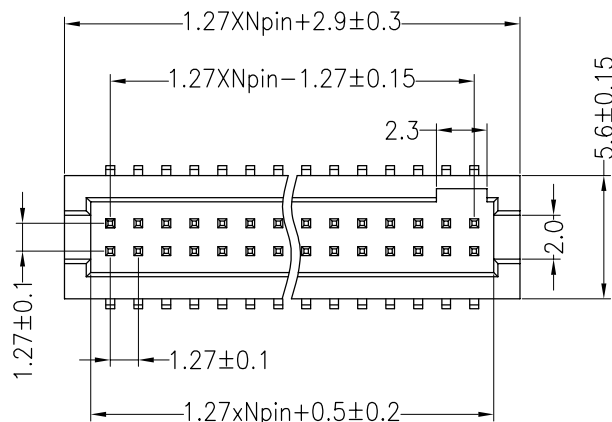


**SPECIFICATIONS**

Rated Current:1.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°c to +105°c

Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Standard: PA6T  
 Max.Processing Temp: 230°C for 30-60 seconds  
 (260°C for 10 seconds)

**Recommended P.C.B Layout(Top Side)**  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

**3232 XX M XX X B K00 X OX**

- No.of Pins: 10-100P
- Contact Plating: G1:Gold Flash, G2:1.5U" Gold, G3:2U" Gold, G4:3U" Gold, G5:5U" Gold, S0:Gold Flash/Tin, SN:Tin
- Insulator Material Option: C=BK-PA6T, D=BK-PA46, E=BK-PA9T, F=BK-LCP
- Packing: 0=PE Bag, A=Tray, T=Tube, R=Reel+Cap, P=Tube+Cap

OPERATION		DRAW	Liu Miao	18.09.18	SCALE	FIT
X.X	±0.30					
X.XX	±0.20	CHECK			UNIT	mm
X.XXX	±0.10					
Angle	±3°	APPROVE			SIZE	A4
DIM	TOL					
		SHEET			1/1	PART NO.
		PROJ.			TITLE:	3232XXMXXXBK00X0X

**WFD** 深圳市旺富达电子有限公司  
 CONN SHEN ZHEN WFD ELECTRONICS CO., LTD

A0	2018.09.18	NEW DRAWING	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE

PART NO. 3232XXMXXXBK00X0X  
 TITLE: 1.27Box Header Npin H5.7 SMT